

AvaSpire® AV-848 polyaryletherketone

AvaSpire® AV-848 is a high-temperature, polyaryletherketone (PAEK) that offers several key performance advantages over comparable grades of PEEK above 150°C, including better dimensional

stability, lower CLTE from 150°C to 240°C, and lower modulus for greater flexibility at room temperature.

• Natural: AvaSpire® AV-848 NT

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Material Status	 Commercial: Active 		
Availability	 Africa & Middle East Asia Pacific Europe	Latin AmericaNorth America	
Features	Chemical ResistantDuctileFatigue ResistantFlame Retardant	Good Dimensional StabilityGood Impact ResistanceHigh Heat Resistance	
Uses	 Oil/Gas Applications 	 Seals 	
RoHS Compliance	 Contact Manufacturer 		
Appearance	 Natural Color 		
Forms	 Pellets 		
Processing Method	Extrusion Blow MoldingFiber (Spinning) ExtrusionFilm ExtrusionInjection Blow MoldingInjection Molding	MachiningProfile ExtrusionThermoformingWire & Cable E	g
Physical	T	ypical Value Unit	Test method
Density / Specific Gravity		1.32	ASTM D792
Water Absorption (24 hr)		0.50 %	ASTM D570
Mechanical	T	ypical Value Unit	Test method
Tensile Modulus ¹		3100 MPa	ASTM D638
Tensile Strength ¹		94.0 MPa	ASTM D638
Tensile Elongation			ASTM D638
Yield ¹		6.7 %	
Break ²		75 %	
Break ¹		35 %	
Flexural Modulus		3300 MPa	ASTM D790
Flexural Strength		134 MPa	ASTM D790
Compressive Strength		118 MPa	ASTM D695
Shear Strength		82.0 MPa	ASTM D732

Impact	Typical Value Unit	Test method
Notched Izod Impact	75 J/m	ASTM D256
Unnotched Izod Impact	No Break	ASTM D4812
Thermal	Typical Value Unit	Test method
Deflection Temperature Under Load	//	ASTM D648
1.8 MPa, Annealed	252 °C	
Glass Transition Temperature	158 °C	ASTM D3418
Peak Melting Temperature	340 °C	ASTM D3418
Specific Heat		DSC
50°C	1650 J/kg/°C	
200°C	1660 J/kg/°C	
Thermal Conductivity	0.22 W/m/K	ASTM E1530
Electrical	Typical Value Unit	Test method
Dielectric Strength	/1	ASTM D149
0.0500 mm, Amorphous Film	180 kV/mm	
Dielectric Constant	·	ASTM D150
60 Hz	3.21	
1 kHz	3.23	
1 MHz	3.18	
Dissipation Factor		ASTM D150
60 Hz	2.0E-3	
1 kHz	1.0E-3	
1 MHz	6.0E-3	
Fill Analysis	Typical Value Unit	Test method
Melt Viscosity ³	500 Pa·s	ASTM D3835
Injection	Typical Value Unit	
Drying Temperature	149 °C	
Drying Time	4.0 hr	
Rear Temperature	366 °C	
Middle Temperature	371 °C	
Front Temperature	377 °C	
Nozzle Temperature	382 °C	
Processing (Melt) Temp	382 to 404 °C	
Mold Temperature	166 to 193 °C	
Injection Rate	Fast	
Screw Compression Ratio	2.0:1.0 to 3.0:1.0	
Injection Notes		
Injection Notes Back Pressure: Minimum		
Back 17000ard, Will III Turl I		

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Notes

Typical properties: these are not to be construed as specifications.

- ¹ 50 mm/min
- ² 5.1 mm/min
- 3 @400°C/1000 sec-1

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